

FEOC Compliance Certificate

by Prospector Labs · prospectorlabs.io

Issued: 2026-06-08

Verification ID: FEOC-9D271A7BDADB

Source: live federal-list snapshot

Semiconductor Manufacturing International (Tianjin) Corporation

China · COVERED NATION · Entity · ID: NK-eESLGXWnt6BaF4va7P9wo4

FEOC FLAGGED

Why this matters: Semiconductor Manufacturing International (Tianjin) Corporation appears on a critical federal screening list. Equipment, services, or transactions involving this entity likely fail FEOC requirements for IRA tax credits (45X, 48E, 30D). Confirm identity against the cited authority before procurement or compliance decisions.

FEDERAL-LIST SCREENING MATRIX

| LIST | AUTHORITY | STATUS | LISTED AS | SEVERITY |
|--|------------------|------------|---|----------|
| OFAC SDN | Treasury OFAC | Not listed | — | CRITICAL |
| BIS Entity List | Commerce / BIS | Not listed | — | CRITICAL |
| DOD 1260H (Chinese Military Companies) | DOD | Listed | Semiconductor Manufacturing International (Tianjin) Corporation | CRITICAL |
| UFLPA Entity List | DHS / FLETF | Not listed | — | CRITICAL |
| CBP Withhold Release Orders | DHS / CBP | Not listed | — | CRITICAL |
| BIS Denied Persons | Commerce / BIS | Not listed | — | HIGH |
| BIS Military End User | Commerce / BIS | Not listed | — | HIGH |
| BIS Unverified List | Commerce / BIS | Not listed | — | MEDIUM |
| State ITAR Debarred | State Department | Not listed | — | HIGH |
| State Nonproliferation | State Department | Not listed | — | HIGH |

ALSO KNOWN AS

SMIC Tianjin

SANCTIONS PROGRAMS / AUTHORITIES

US-DOD-1260H

SANCTIONING AUTHORITY NOTES

2025-01-07 - 2021-06-03

DATA SOURCES

Informational only. Not legal advice. Cross-list matching is name-based — verify identity with the cited source authority before procurement, financing, or compliance decisions.

This document is a point-in-time snapshot. The Verification ID can be reproduced from the entity ID + the date of issue.

Verification ID: FEOC-9D271A7BDADB · Entity ID: 5b0b215c-1a80-4470-ada8-b7a9717309b3 · Issued 2026-06-08